Electronic Patent Application Fee Transmittal							
Application Number:	10568755						
Filing Date:	21-Feb-2006						
Title of Invention:	Microsystem component and method for gluing microcomponents to a substrate						
First Named Inventor/Applicant Name:	Stefan Boehm						
Filer:	Michael E. Whitham						
Attorney Docket Number:	03100282AA						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	130	130		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Tot	940		